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DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

Docket Number 13DV13367

As a below named inventor, I hereby declare that:

My residence, post office add	lrace and citizenship are	as stated below next to my	nama
MV residence. Dost office add	iress, and cilizenship are	as stated below next to my	mame.

			below) or an original, first and h a patent is sought on the in	
METHOD FOR MAK	ING A FIBER REINFORG	CED COMPOSITE	ARTICLE AND PRODUCT-	
the specification of which			•	
is attached hereto				
OR was filed on	as United States A	Application Number of	or PCT International Applicati	on Number
and was amended on		• •	or international rippinous	
I hereby state that I have rev any amendment specifically		contents of the above	e identified specification, incl	uding the claims, as amended by
I acknowledge the duty to dis	sclose information which is	material to patentab	ility as defined in Title 37 Cod	de of Federal Regulations, §1.56.
or inventor's certificate, or §3	665 (a) of any PCT internat bw and have also identified ng a filing date before that	ional application white below any foreign a	ch designated at least one co pplication for patent or inven	foreign application(s) for patent ountry other than the United tor's certificate, or of any PCT Priority Claimed
			(Day/Month/Year Filed)	☐ Yes ☐ No
(Number)	(Count	ry)	(Day/Month/Year Filed)	☐ Yes ☐ No
(Number)	` (Coun	try)	(Day/Month/Year Filed)	
Additional foreign application	on numbers are listed on a sup	oplemental priority data	sheet attached hereto.	
I hereby claim the benefit und (Application Num		(Filing Date)	United States provisional ap	oplication(s) listed below. Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto.
this application is not disclos of Title 35, United States Co.	gnating the United States of ed in the prior United State de §112, I acknowledge the ions §1.56 which became a	of America, listed be es or PCT Internation e duty to disclose in	ow and, insofar as the subject al application in the manner formation which is material to	or §365 (c) of any PCT ct matter of each of the claims of provided by the first paragraph patentability as defined in Title cation and the national or PCT
(Application Nun	nber)	(Filing Date)	(Status - p.	atented, pending, abandoned)
(Application Num	ber)	(Filing Date)	(Status - pa	atented, pending, abandoned)
I hereby appoint the regist transact all business in the				secute this application and to
Address all telephone calls to	o: NATHAN D. HE	RKAMP at	telephone number(513	3) 243-6473
Address all correspondence t	O: GENERAL ELECTR ATTN: ANDREW C GE AIRCRAFT ENG ONE NEUMANN WA CINCINNATI, OH 4	. HESS SINES AY, M/D H17	Que Here	ode
GEAE (9/97)	CUSTOMER NUMB	ER: 006111	PATENT TRACEMENT OFFICE	Page 1 of 2

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

SOLE OR FIRST INVENTOR:
Full name: JACK WILBUR BALDWIN
Signature: Signature: Date 57/17/2001
Residence: WEST CHESTER, OHIO Citizenship: US City and State
Post Office Address: 7947 RED MILL DRIVE, WEST CHESTER, OH 45069
SECOND JOINT INVENTOR:
Signature: JOHN ANDREW RAVENHALL Niddle Name Last Name Date 07/17/2001
Residence: HAMILTON, OHIO Citizenship: US
Post Office Address: 5525 LE SOURDESVILLE-WEST CHESTER ROAD, HAMILTON, OH 45011
THIRD JOINT INVENTOR:
Full name: BRUCE CLARK BUSBEY
Signature: Last Name Last Name Date 07/17/2001
Residence: LOVELAND, OHIO Citizenship: US
Post Office Address: 4292 CRESTVIEW DRIVE, LOVELAND, OH 45140
FOURTH JOINT INVENTOR: Full name:
First Name Middle Name Last Name
Signature: Date
Residence: City and State
Post Office Address:

GEAE (9/97)